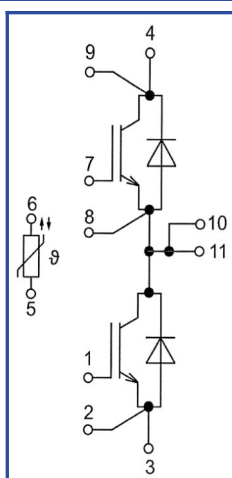
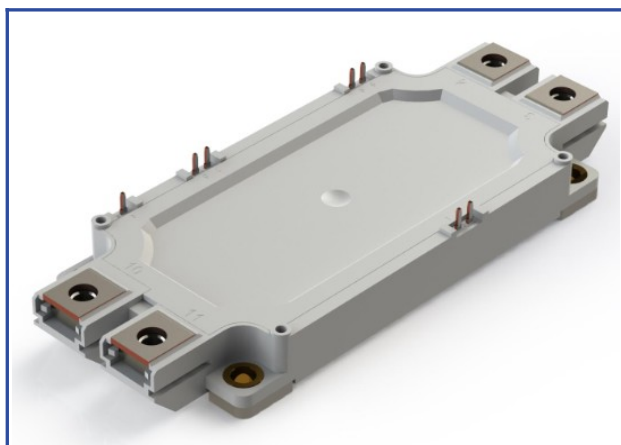


**Low Inductance IGBT Module with 17 mm Height Housing**
**1700 V 600 A**

**Chip features**

- IGBT chip
  - low  $V_{CE(sat)}$  value
  - 10  $\mu s$  short circuit duration at 150°C
  - square RBSOA of 2xI<sub>C</sub>
- FRD chip
  - fast and soft reverse recovery
  - low voltage drop

**Design features**

- copper baseplate
- Al<sub>2</sub>O<sub>3</sub> DBC substrate
- ultrasonic welded power terminals
- improved thermal cycling
- RoHS compliant
- low inductance value

**Typical application**

- AC motor drives
- solar inverters
- air conditioning
- high power converters and UPS
- Inverters for wind energy converters

**Maximum rated values**

| Definition                                       | Symbol         | Conditions                                                                                                        | Value      | Unit    |
|--------------------------------------------------|----------------|-------------------------------------------------------------------------------------------------------------------|------------|---------|
| <b>IGBT</b>                                      |                |                                                                                                                   |            |         |
| Collector-Emitter voltage                        | $V_{CES}$      | $V_{GE} = 0$ .                                                                                                    | 1700       | V       |
| Maximum allowable collector current (continuous) | $I_{C\ 25}$    | $T_{vj\ (max)} = 175^{\circ}C$ ; $T_c = 25^{\circ}C$ .                                                            | 922        | A       |
|                                                  | $I_{C\ 80}$    | $T_{vj\ (max)} = 175^{\circ}C$ ; $T_c = 80^{\circ}C$ .                                                            | 600        | A       |
| Repetitive peak collector current <sup>*1</sup>  | $I_{CRM}$      | $I_{CRM} = 3 \times I_{C\ nom}$ ; $t_p = 1\ ms$ .                                                                 | 1800       | A       |
| Short-circuit duration                           | $t_{psc}$      | $T_{vj} = 25^{\circ}C$ ; $V_{GE} = \pm 15\ V$ ; $V_{CE} = 1000\ V$ ;<br>$R_{G\ on} = R_{G\ off} = 1.5\ \Omega$ .  | 10         | $\mu s$ |
|                                                  |                | $T_{vj} = 150^{\circ}C$ ; $V_{GE} = \pm 15\ V$ ; $V_{CE} = 1000\ V$ ;<br>$R_{G\ on} = R_{G\ off} = 1.5\ \Omega$ . | 10         |         |
| Gate-Emitter voltage                             | $V_{GES}$      |                                                                                                                   | $\pm 20$   | V       |
| Junction operating temperature                   | $T_{vj\ (op)}$ |                                                                                                                   | -40...+150 | °C      |
| <b>Inverse diode</b>                             |                |                                                                                                                   |            |         |
| Repetitive peak reverse voltage                  | $V_{RRM}$      | $V_{GE} = 0\ V$ .                                                                                                 | 1700       | V       |
| Maximum allowable forward current (continuous)   | $I_{F\ 25}$    | $T_{vj\ (max)} = 175^{\circ}C$ ; $T_c = 25^{\circ}C$ .                                                            | 591        | A       |
|                                                  | $I_{F\ 80}$    | $T_{vj\ (max)} = 175^{\circ}C$ ; $T_c = 80^{\circ}C$ .                                                            | 439        | A       |
| Repetitive peak forward current <sup>*1</sup>    | $I_{FRM}$      | $I_{FRM} = 3 \times I_{F\ nom}$ ; $t_p = 1\ ms$ .                                                                 | 1800       | A       |
| Junction operating temperature                   | $T_{vj\ (op)}$ |                                                                                                                   | -40...+150 | °C      |
| <b>Module</b>                                    |                |                                                                                                                   |            |         |
| Storage temperature                              | $T_{stg}$      |                                                                                                                   | -40...+50  | °C      |
| Isolation voltage                                | $V_{isol}$     | AC sin 50 Hz; $t = 1\ min$ .                                                                                      | 4000       | V       |

<sup>\*1</sup> Pulse width and repetition rate should be such that device junction temperature does not exceed maximum  $T_{vj}$  rating



### Characteristics

| Definition                           | Symbol         | Conditions                                                                                                                                           | Value                                                                                 |              |               | Unit.        |                                |            |
|--------------------------------------|----------------|------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|--------------|---------------|--------------|--------------------------------|------------|
|                                      |                |                                                                                                                                                      | min.                                                                                  | typ.         | max.          |              |                                |            |
| IGBT                                 |                |                                                                                                                                                      |                                                                                       |              |               |              |                                |            |
| Collector-Emitter saturation voltage | $V_{CEsat}$    | $V_{GE} = +15\text{ V}; I_C = 600\text{ A};$<br>$t_u = 1000\text{ }\mu\text{s}.$                                                                     | $T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 150^\circ\text{C}$                           | 1.80<br>2.31 | 1.84<br>2.39  | 1.96<br>2.53 | V<br>V                         |            |
| Gate-Emitter threshold voltage       | $V_{GE(th)}$   | $I_C = 3\text{ mA}; V_{CE} = V_{GE}; T_{vj} = 25^\circ\text{C};$<br>$t_u = 2\text{ ms}.$                                                             |                                                                                       | 5.30         | 5.60          | 5.80         | V                              |            |
| Collector-Emitter cut-off current    | $I_{CES}$      | $V_{CE} = 1700\text{ V};$<br>$t_u = 50\text{ ms}; V_{GE} = 0.$                                                                                       | $T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 150^\circ\text{C}$                           | -<br>-       | 11.00<br>3.50 | 300<br>6.00  | $\mu\text{A}$<br>mA            |            |
| Gate-Emitter leakage current         | $I_{GES}$      | $V_{CE} = 0; V_{GE} = \pm 20\text{ V}; T_{vj} = 25^\circ\text{C};$<br>$t_u = 30\text{ ms}.$                                                          |                                                                                       | -            | 11.00         | 300          | nA                             |            |
| Input capacitance                    | $C_{ies}$      | $V_{CE} = 25\text{ V}; V_{GE} = 0\text{ V};$                                                                                                         |                                                                                       | -            | -             | -            | nF                             |            |
| Reverse transfer capacitance         | $C_{res}$      | $f = 1\text{ MHz}; T_{vj} = 25^\circ\text{C}.$                                                                                                       |                                                                                       | -            | -             | -            | nF                             |            |
| Total gate charge                    | $Q_G$          | $I_C = 600\text{ A}; V_{CE} = 920\text{ V};$<br>$V_{GE} = -8...+15\text{ V}.$                                                                        |                                                                                       | -            | 3300          | -            | nC                             |            |
| Internal gate resistance             | $R_{Gint}$     | $T_{vj} = 25^\circ\text{C}.$                                                                                                                         |                                                                                       | -            | 1.20          | -            | $\Omega$                       |            |
| Turn-on delay time                   | $t_{d(on)}$    | $V_{CE} = 920\text{ V};$<br>$V_{GE} = \pm 15\text{ V};$<br>$I_{C\text{ max}} = 600\text{ A};$<br>$R_G = 1.5\text{ }\Omega;$<br>$L_s = 56\text{ nH}.$ | $T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 150^\circ\text{C}$                           | -<br>-       | -<br>-        | -<br>-       | ns                             |            |
| Rise time                            | $t_{ri}$       |                                                                                                                                                      | $T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 150^\circ\text{C}$                           | -<br>-       | -<br>-        | -<br>-       | ns                             |            |
| Turn-on energy                       | $E_{on}$       |                                                                                                                                                      | $T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 150^\circ\text{C}$                           | -<br>-       | 143<br>201    | -<br>-       | mJ                             |            |
| Turn-off delay time                  | $t_{d(off)}$   |                                                                                                                                                      | $T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 150^\circ\text{C}$                           | -<br>-       | -<br>-        | -<br>-       | ns                             |            |
| Fall time                            | $t_{fi}$       |                                                                                                                                                      | $T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 150^\circ\text{C}$                           | -<br>-       | -<br>-        | -<br>-       | ns                             |            |
| Turn-off energy                      | $E_{off}$      |                                                                                                                                                      | $T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 150^\circ\text{C}$                           | -<br>-       | 147<br>205    | -<br>-       | mJ                             |            |
| Collector-emitter threshold voltage  | $V_{CE0}$      |                                                                                                                                                      | $V_{GE} = +15\text{ V}; T_{vj} = 150^\circ\text{C};$                                  |              | -             | -            | 0.85                           | V          |
| On-State slope resistance (IGBT)     | $r_{CE0}$      |                                                                                                                                                      | $I_{CE1} = 150\text{ A}; I_{CE2} = 600\text{ A};$<br>$t_u = 1000\text{ }\mu\text{s}.$ |              | -             | -            | 2.68                           | m $\Omega$ |
| Thermal resistance junction to case  | $R_{th(j-c)}$  |                                                                                                                                                      | DC; $I_{test} = 1.5\text{ A};$<br>$V_{GE} = +15\text{ V}.$                            |              | -             | -            | 0.049                          | K/W        |
| Inverse diode                        |                |                                                                                                                                                      |                                                                                       |              |               |              |                                |            |
| Forward voltage drop                 | $V_F$          | $I_F = 600\text{ A};$<br>$V_{GE} = 0; t_u = 1000\text{ }\mu\text{s}.$                                                                                | $T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 150^\circ\text{C}$                           | 1.85<br>2.18 | 1.91<br>2.26  | 2.02<br>2.40 | V<br>V                         |            |
| Reverse recovery time                | $t_{rr}$       | $V_{CE} = 920\text{ V};$<br>$V_{GE} = \pm 15\text{ V};$<br>$I_{C\text{ max}} = 600\text{ A};$<br>$R_G = 1.5\text{ }\Omega;$<br>$L_s = 56\text{ nH}.$ | $T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 150^\circ\text{C}$                           | -<br>-       | -<br>-        | -<br>-       | ns<br>ns                       |            |
| Peak reverse current                 | $I_{RM}$       |                                                                                                                                                      | $T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 150^\circ\text{C}$                           | -<br>-       | 500<br>500    | -<br>-       | A<br>A                         |            |
| Recovered charge                     | $Q_r$          |                                                                                                                                                      | $T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 150^\circ\text{C}$                           | -<br>-       | 156<br>185    | -<br>-       | $\mu\text{C}$<br>$\mu\text{C}$ |            |
| Reverse recovery energy              | $E_{rec}$      |                                                                                                                                                      | $T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 150^\circ\text{C}$                           | -<br>-       | 106<br>129    | -<br>-       | mJ<br>mJ                       |            |
| Threshold voltage                    | $V_{(T0)}$     |                                                                                                                                                      | $T_{vj} = 150^\circ\text{C}; V_{GE} = 0; I_{CE1} = 150\text{ A};$                     |              | -             | -            | 0.99                           | V          |
| Forward slope resistance             | $r_T$          |                                                                                                                                                      | $I_{CE2} = 600\text{ A}; t_u = 1000\text{ }\mu\text{s}$                               |              | -             | -            | 2.23                           | m $\Omega$ |
| Thermal resistance junction to case  | $R_{th(JC-D)}$ |                                                                                                                                                      | DC; $I_{test} = 1.5\text{ A};$<br>$V_{GE} = 0\text{ V}.$                              |              | -             | -            | 0.110                          | K/W        |



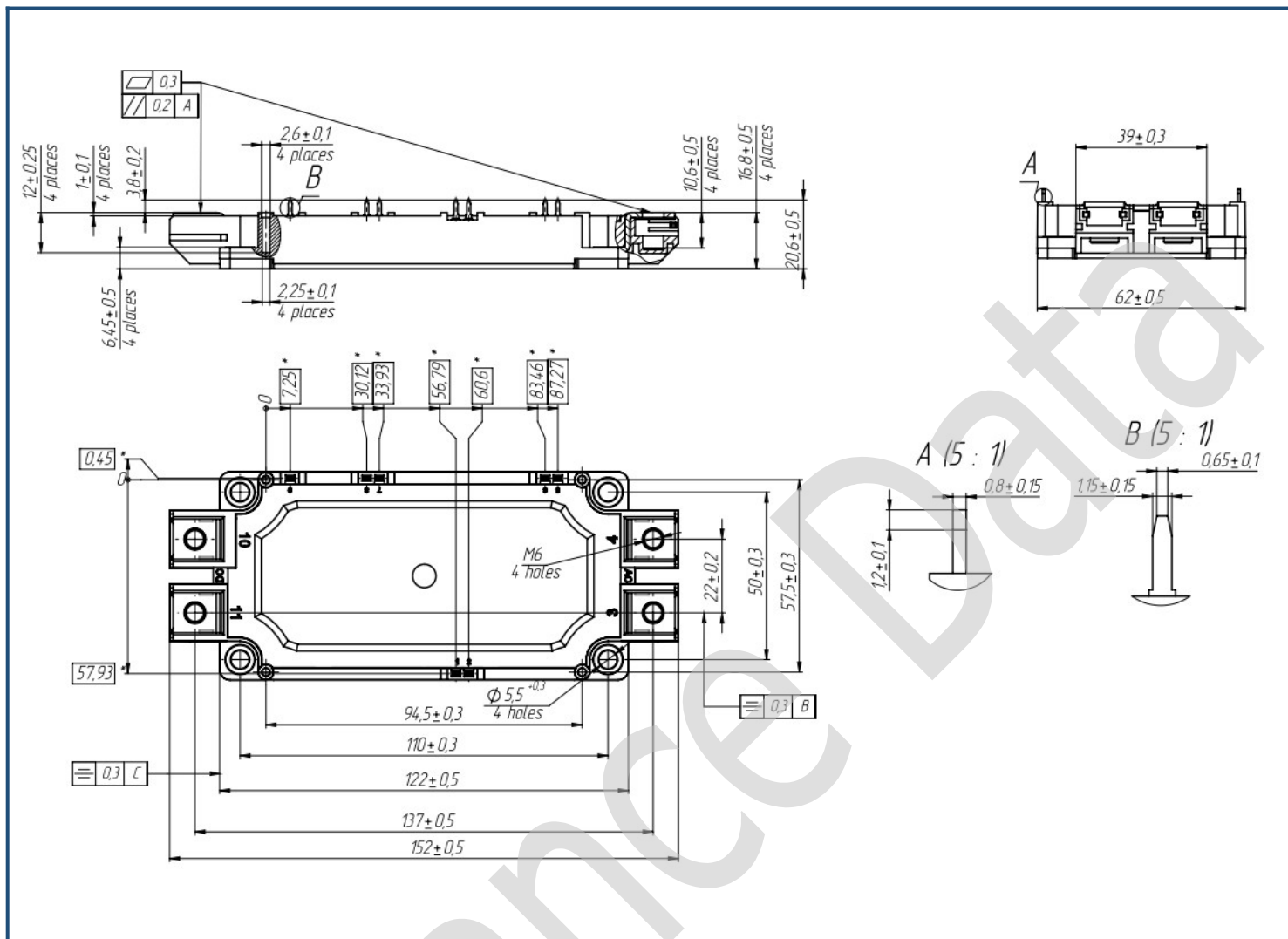
| Module                                 |                    |                                                                                                                                |                       |      |       |       |     |
|----------------------------------------|--------------------|--------------------------------------------------------------------------------------------------------------------------------|-----------------------|------|-------|-------|-----|
| Pin resistance                         | R <sub>Pxy</sub>   | T <sub>vj</sub> = 25°C.                                                                                                        | R <sub>P10/11-3</sub> | -    | 0.92  | 1.00  | mΩ  |
|                                        |                    |                                                                                                                                | R <sub>P10/11-4</sub> | -    | 0.59  | 1.00  |     |
| Parasitic inductance between terminals | L <sub>Pce</sub>   |                                                                                                                                |                       | -    | 26.00 | -     | nH  |
| Thermistor resistance                  | R <sub>t</sub>     | T <sub>vj</sub> = 25°C                                                                                                         |                       | 4850 | -     | 6225  | Ω   |
|                                        |                    | T <sub>vj</sub> = 100°C                                                                                                        |                       | 475  | -     | 554   |     |
| Coefficient of temperature sensitivity | B <sub>25/50</sub> | R <sub>2</sub> = R <sub>25</sub> exp [B <sub>25/50</sub> (1/T <sub>2</sub> - 1/T <sub>1</sub> )],<br>T <sub>1</sub> = 298,15 K |                       | -    | 3375  | -     | κ   |
| Thermal resistance case to heatsink    | R <sub>thCH</sub>  | per module                                                                                                                     |                       | -    | 0.009 | 0.014 | K/W |
| Mounting torque for screws to heatsink | M <sub>s</sub>     | to heatsink M5                                                                                                                 |                       | 3    | -     | 6     | N*m |
| Mounting torque for terminal screws    | M <sub>t</sub>     | to terminals M6                                                                                                                |                       | 3    | -     | 6     | N*m |
| Weight                                 | W                  |                                                                                                                                |                       | -    | 360   | -     | g   |

" - " — data will be refined as additional tests are conducted and statistics are collected.

### Notes:

- Insulating material operating temperature 125°C max;
- Case temperature 125°C max;
- The recommended operating junction temperature  $T_{vj \text{ op}} = -40...+150^{\circ}\text{C}$ .

## Overall dimensions: Package type – DA



## Part numbering guide

|      |   |    |    |    |   |     |   |                                  |
|------|---|----|----|----|---|-----|---|----------------------------------|
| MIDA | - | HB | 17 | SG | - | 600 | N |                                  |
| MIDA |   |    |    |    |   |     |   | IGBT module package type: DA     |
|      |   | HB |    |    |   |     |   | 2 switches as Half-Bridge        |
|      |   |    | 17 |    |   |     |   | Voltage rating ( $V_{CES}/100$ ) |
|      |   |    |    | SG |   |     |   | IGBT+FRD chipset modification    |
|      |   |    |    |    |   | 600 |   | Current Rating                   |
|      |   |    |    |    |   |     | N | Climatic version: normal climate |

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